

## FEATURES

- Small Form Factor Package(GW): 9 pins coplanar
- Integrated Design Optimizes Performance at Bit Rates up to 12.5Gb/s
- High Sensitivity: -27dBm (typ.)
- Electrical Differential Output
- Wide Bandwidth: 10.5GHz (typ.)
- Operates in both C and L wavelength bands



## APPLICATIONS

This APD with HBT preamplifier is intended to function as an optical receiver at 1,310nm or 1,530-1,610nm in SONET, SDH, DWDM or other optical fiber systems operating up to 12.5Gb/s. The typical transimpedance ( $Z_t$ ) value of  $1,300\Omega$  optimizes the total bandwidth for 10Gb/s application. The detector preamplifier is DC coupled and has an electrical differential output.

## DESCRIPTION

The FRM5N141GW incorporates a high bandwidth InGaAs APD photo diode, a GaAs HBT IC amplifier in a hermetically sealed Small Form Factor package (SFF). The APD is processed with modern MOVPE techniques resulting in a reliable performance over a wide range of operating conditions. The lens coupling system and the single mode fiber are assembled using Nd YAG welding.

## ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Storage Temperature	$T_{stg}$	-40 to +85	$^\circ\text{C}$
Operating Temperature	$T_{op}$	-5 to +75	$^\circ\text{C}$
Supply Voltage	$V_{ss}$	-6 to 0	V
PIN Reverse Voltage	$V_R$	0 to $V_B$ (Note)	V
PIN Reverse Current	$I_{R(peak)}$	3	mA

Note: Since  $V_B$  may vary from device-to-device,  $V_B$  data is attached to each device for reference.

## OPTICAL &amp; ELECTRICAL CHARACTERISTICS

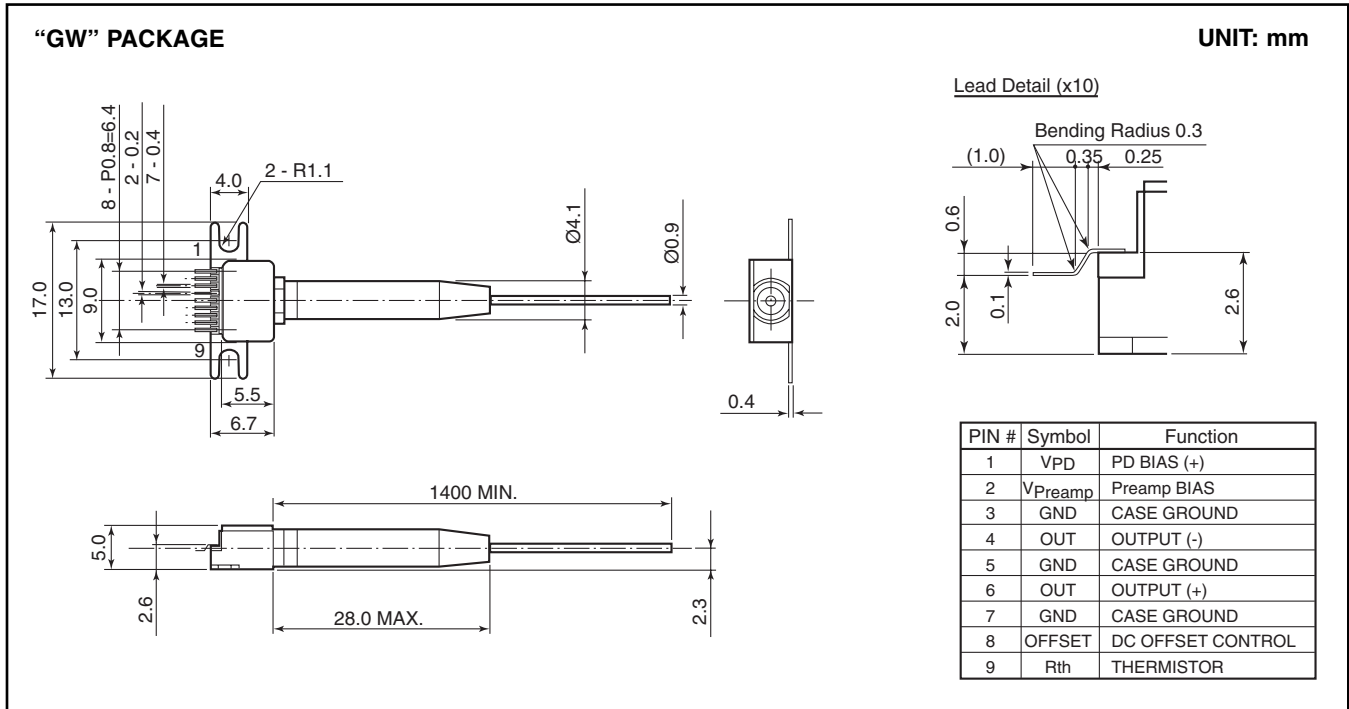
(T<sub>C</sub>=25°C, λ=1,550nm, V<sub>SS</sub>=-5.2V, unless otherwise specified)

Parameter	Symbol	Test Conditions	Limits			Unit	
			Min.	Typ.	Max.		
APD Responsivity	R13	λ = 1,310nm, M=1	0.75	0.85	-	A/W	
	R15	λ = 1,550nm, M=1	0.75	0.90	-		
	R16	λ = 1,610nm, M=1	-	0.80	-		
APD Breakdown Voltage	VB	ID = 10μA	20.0	25.0	30.0	V	
Temperature Coefficient of VB	γ	Note (1)	0.03	0.05	0.07	V/°C	
AC Transimpedance	Z <sub>t</sub>	f = 750MHz, Single-end	900	1300	-	Ω	
Output Common Voltage	V <sub>out</sub>	-	-	-400	-	mV	
Maximum Output Voltage Swing	V <sub>clip</sub>	Saturated Output Voltage	400	600	800	mV	
Bandwidth	BW	-3dB from 750MHz, Pin=-20dBm	M=9	8.5	10.5	-	GHz
			M=3	8.5	10.5	-	
Lower Cut-off Frequency	f <sub>cl</sub>	-3dB from 750MHz, Pin=-20dBm	-	40	100	kHz	
Peaking	d <sub>pk</sub>	130MHz to BW, Pin=-20dBm, M=9	-	0.5	1.5	dB	
Group Delay Deviation	GD	1GHz to 6GHz, Pin=-20dBm, M=9	-	15	40	ps <sub>p-p</sub>	
		1GHz to 8GHz, Pin=-20dBm, M=9	-	30	60		
Output Return Loss	S <sub>22</sub>	130MHz to 6GHz	-	12	-	dB	
		130MHz to 8GHz	-	10	-		
Minimum Sensitivity	P <sub>r</sub>	10Gb/s, NRZ, PRBS=2 <sup>31</sup> -1, B.E.R.=10 <sup>-12</sup> , VR=Optimum	25°C, R <sub>ext</sub> =13dB	-	-27.0	-25.0	dBm
			25°C, R <sub>ext</sub> =10dB	-	-26.0	-	
			25°C, R <sub>ext</sub> =8.2dB	-	-25.0	-	
			70°C, R <sub>ext</sub> =13dB	-	-26.0	-24.0	
Maximum Overload	P <sub>o</sub>	10Gb/s, NRZ, PRBS=2 <sup>31</sup> -1, B.E.R.=10 <sup>-12</sup> , M=3	R <sub>ext</sub> =13dB	-7	-5	-	dBm
			R <sub>ext</sub> =10dB	-	-4.5	-	
			R <sub>ext</sub> =8.2dB	-	-4.0	-	
Optical Return Loss	ORL	λ = 1,550nm	27	-	-	dB	
		λ = 1,310nm	27	-	-		
Power Supply Current	I <sub>ss</sub>	-	-	110	130	mA	
Power Supply Voltage	V <sub>ss</sub>	-	-5.46	-5.20	-4.94	V	
Thermistor Resistance	R <sub>th</sub>	-	9.5	10.0	10.5	kΩ	
Thermistor B Constant	B	-	3800	3900	4000	K	

Note 1: γ=ΔVB/dT<sub>C</sub>

Note: All the parameters are measured with 50Ω, DC-coupled and 0V output offset.

Notes



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